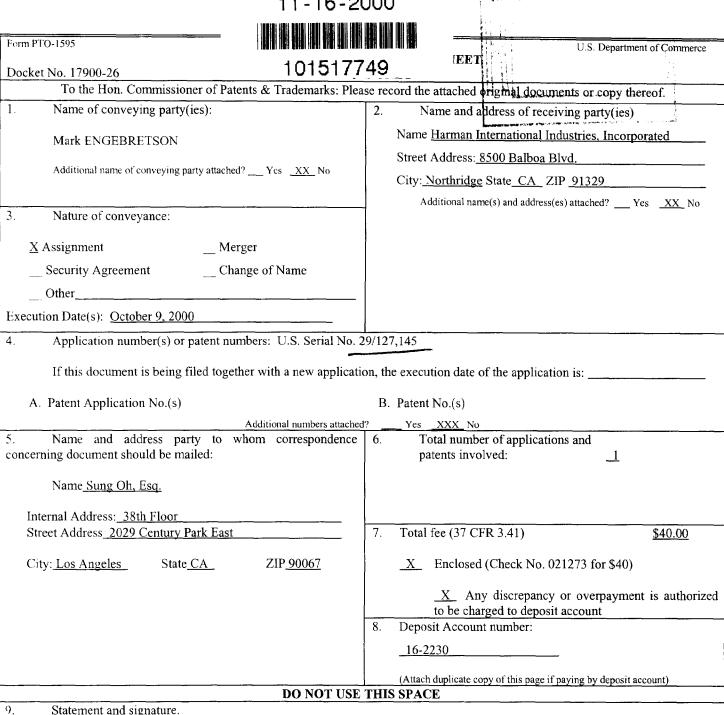
11-16-2000



Mail documents to be recorded with required cover sheet information to:

Signature

Total number of pages including cover sheet, attachments, and document: 4

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the

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original document.

Sung Oh, Reg. No. 45,583

Name of Person Signing

Commissioner of Patents & Trademarks

Box Assignments

Crystal Gateway 4, Room 335 Washington, D.C. 20231

October 30, 2000

Date

PATENT Docket No. 17900-26

ASSIGNMENT

WHEREAS, I, Mark ENGEBRETSON, residing at 4735 Sepulveda Boulevard, Apt. 40, Sherman Oaks, California 91403, the ASSIGNOR herein, have invented a Design for a *Radiation Boundary Integrator* for which I filed application for Design Letters Patent of the United States on July 31, 2000 and was given Serial No. 29/127,145. I have executed the Declaration and Petition concurrently with executing this assignment. I am the sole owner of this invention and improvements; and

WHEREAS, HARMAN INTERNATIONAL INDUSTRIES, INCORPORATED, a Delaware corporation, having a place of business at 8500 Balboa Boulevard, Northridge, California 91329, the ASSIGNEE herein, desires to acquire the entire right, title and interest in and to said invention, and application and patent to be granted and issued thereon;

NOW, THEREFORE, for one dollar (\$1.00) and other valuable consideration, the receipt and legal sufficiency of all of which is hereby acknowledged, I, the said ASSIGNOR, have sold and do hereby sell, assign, transfer and set over unto said ASSIGNEE, its successors and assigns, my entire right, title and interest in and to said inventions and all improvements thereon, in and to said application for Design Letters Patent thereon, in and to applications pertaining to or based upon said inventions and applications, including divisional and continuing applications and continuations-in-part, and in and to any and all Design Letters Patent which may be granted and issued on said inventions and applications, or any of them, not only for, to and in the United States of America, its territories and possessions, but for, to and in all countries foreign thereto, together with and including all priority rights based upon any and all applications in the United States of America covered by this Assignment, and grant to said ASSIGNEE, its successors and assigns, the right to apply for and obtain U.S. Design Letters Patents concerning the invention in its or their own names as sole owner or owners of all right, title and interest in and to said inventions and improvements thereon.

And for the above-named considerations, I do hereby agree that I will, at the request of said ASSIGNEE, execute any and all applications for Design Letters Patent for said inventions and any and all other papers and documents and do all other and further lawful acts that said ASSIGNEE may deem necessary or desirable to obtain DesignLetters Patent on said inventions, to secure the grant of such Design Letters Patent and to perfect and vest in the ASSIGNEE the entire right, title and interest in the inventions, applications and Design Letters Patent.

And for the above-named considerations, I do hereby authorize and empower the ASSIGNEE, its successors and assigns, to apply for and obtain, in its or their own names, Design Letters Patent for the said inventions before competent International Authorities and in any and all countries foreign to the United States in which applications for Design Letters Patent can be so made or Design Letters Patent so obtained.

Dated: 10 - 9 - 2000

Mark Engebretson

LA: 239472 v01 09/22/2000

PATENT

REEL: 11236 FRAME: 0743